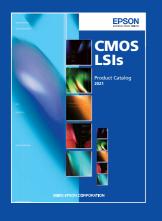


EPSON Microcontrollers



ASICs



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Seiko Epson Corp. Sales & Marketing Division

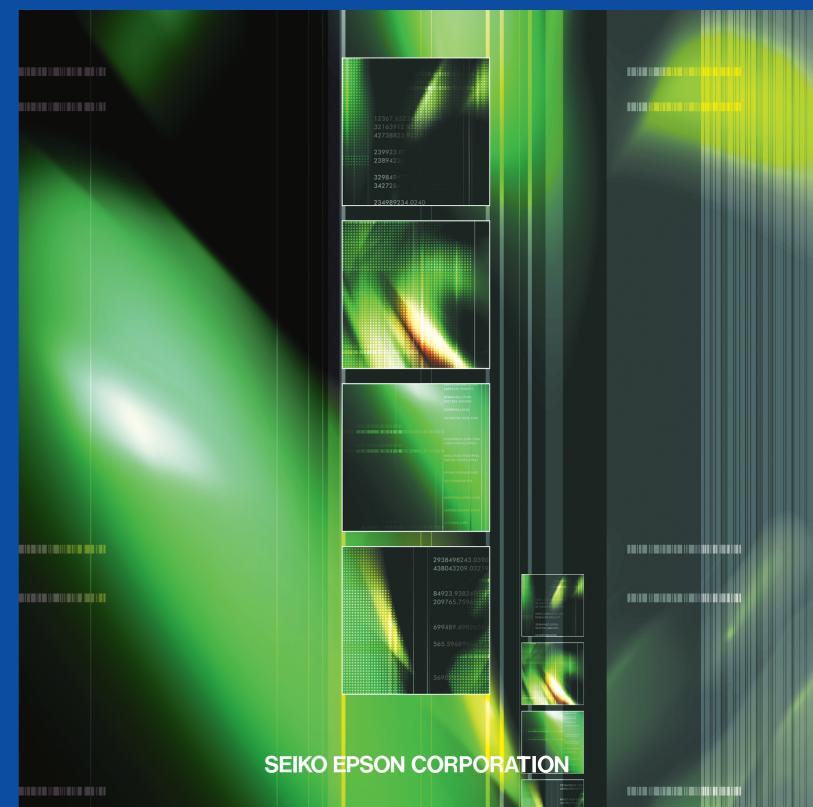
Device Sales & Marketing Department

29th Floor, JR Shinjuku Miraina Tower, 4-1-6 Shinjuku, Shinjuku-ku, Tokyo 160-8801, Japan

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First Issue April 2002 Revised March 2021 in JAPAN \oplus

Microcontrollers



Business Concept

Expanding use of smartphones and tablets is giving broadband internet and wireless communications even greater roles in our daily lives, and making the arrival of the ubiquitous network society an inevitable reality. In particular, semiconductors for use in portable devices, information terminals, in-vehicle devices and FA devices are expected to provide higher performance in terms of thinner structure, lighter weight, and longer operation with limited power supply. We have been focusing on the creation of compact, low-power semiconductors since we started the development of CMOS LSI for watches in 1969. Since then, we have steadily built up our expertise in energy-saving, space-saving, and time-saving designs. This has enabled us to quickly obtain the semiconductor development technology needed to meet the demands of the new era of ubiquitous networks. Our concept is to develop "saving technologies" to reduce power consumption, development times, and implementation space. Our goal is to be a true partner for you, providing you with strategic advantages, enhancing your customer value based on our "saving technologies" and mixed analog/ digital technologies that we have cultivated, as well as our design capabilities, manufacturing capabilities and stable supply that can satisfy your detailed requirements.

Environmental Responsibility

Epson semiconductor technology provides environmental value to customers by creating and manufacturing eco-friendly products.

1) We Epson's products are surely complying with the Eu-RoHS (2011/65/EU) Directive.

2) We are releasing information about the containing chemical substances of products at web-site. Product of QFP & BGA are described in the following URL. global.epson.com/products and drivers/semicon/information/package lineup.html *Some products

global.epson.com/products_and_drivers/semicon/information/package_lineup.ntml *Some pro are excluded.

Environmental management system third party certification status ISO14001

Type of certification: ISO 14001: 2015, JIS Q 14001: 2015

Awarded to: TOHOKU EPSON CORPORATION, SEIKO EPSON CORPORATION

(Fujimi Plant, Suwa Minami Plant)

Certified by : Bureau Veritas Japan Co., Ltd. Date of certification : April 3, 1999

Type of certification : ISO 14001: 2015

Awarded to : Singapore Epson Industrial Pte. Ltd.

Certified by: SGS Date of certification: Jan 12, 1999







Epson's Quality Policy

Keeping the customer in mind at all times, we make the quality of our products and services our highest priority. From the quality-assurance efforts of each employee to the quality of our company as a whole, we devote ourselves to creating products and services that please our customers and earn their trust. Epson has acquired ISO9001 and IATF16949 certification with its IC, module and their application products.

Quality Management system third party certification status

Type of Certification: ISO9001: 2015, JIS Q 9001: 2015

Awarded to: TOHOKU EPSON CORPORATION, SEIKO EPSON CORPORATION

(Fujimi Plant, Suwa Minami Plant, Tokyo Office)

Certified by: Bureau Veritas Japan Co., Ltd.

Certificate No.: 3762381

Initial Date of Certification : October 10, 1993

Type of Certification: ISO9001: 2015

Awarded to: Singapore Epson Industrial Pte. Ltd.

Certified by: SGS

Certificate No. : SG03/00011

Initial Date of Certification: February 4, 2003

IATF16949

Type of Certification: IATF16949:2016

Awarded to: TOHOKU EPSON CORPORATION, SEIKO EPSON CORPORATION (Fujimi Plant, Suwa Minami Plant, Tokyo Office), Epson Europe Electronics GmbH, Epson America, Inc., Epson Canada Ltd.(Vancouver Design Center)

Certified by: Bureau Veritas Japan Co., Ltd.

Certificate No.: 281371

Initial Date of Certification: Dec 9, 2017

Type of Certification: IATF16949:2016

Awarded to: Singapore Epson Industrial Pte. Ltd.

Certified by : SGS

Certificate No.: SG07/00021

Initial Date of Certification : May 2, 2018

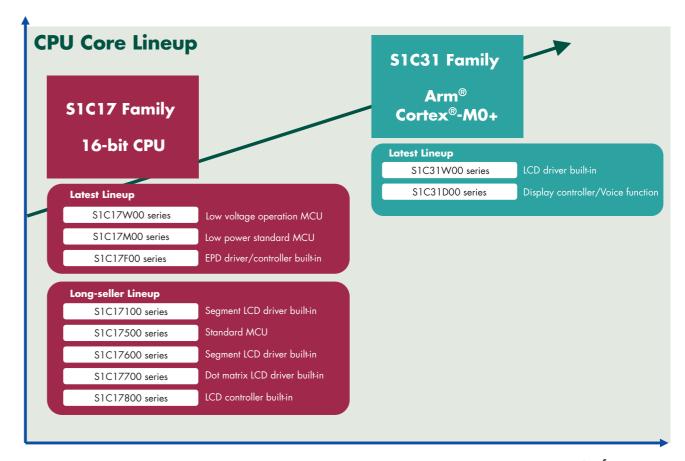








MCUs



Performance

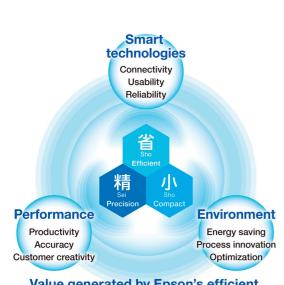
C O N T E N T S

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Epson microcontroller overview	6	Development environments	22-25
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MCUs

History of Epson semiconductor

Value Generated by Epson Technologies



Value generated by Epson's efficient, compact and precision technologies

Smart technologies

Create convenient and easy-to-use products that can be used anytime and anywhere, and which help customers reduce waste, and save effort, time and money.

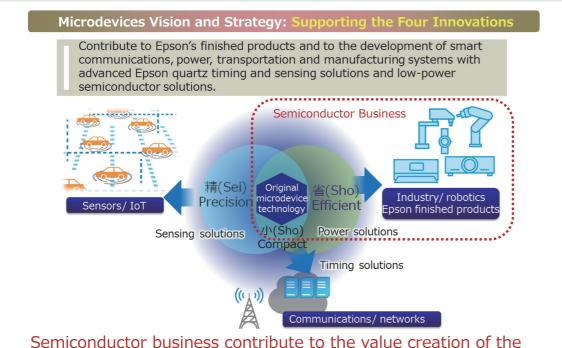
Environment

Leverage Epson products to reduce environmental impact by improving customers' work processes, and contribute to a sustainable society.

Performance

Use outstanding products to contribute to customers' performance through productivity, accuracy and creativity.

The role of Microdevices Div. and Semiconductor Business



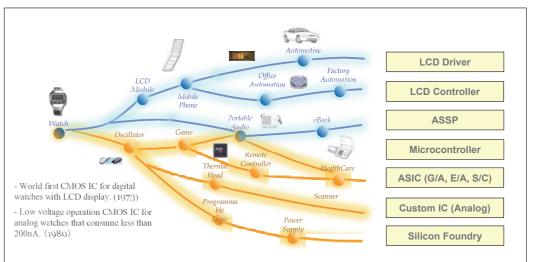
Epson finished product, by advanced "Power Saving" solutions.

History of Epson semiconductor

MCUs

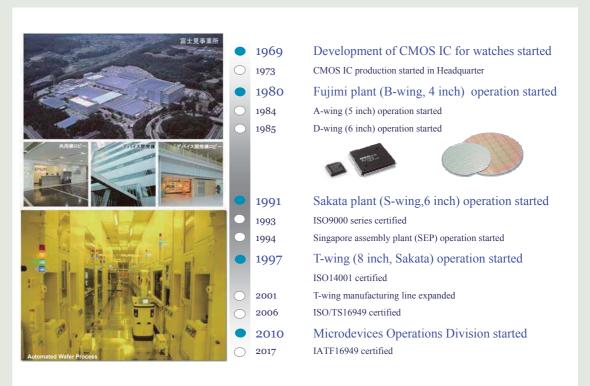
History of Epson Semiconductor's Technology

As the semiconductor division of "worldwide watch maker Seiko", semiconductor business has expanded into LCD Drivers, ASICs and MCUs from IC for Watches. These businesses are all based on Epson's energy-saving technology.



Energy-Saving Technology; Technology that reduces power consumption from both sides of process and circuit have been nurtured by Epson over 40 years since division was founded.

Epson Semiconductor's History



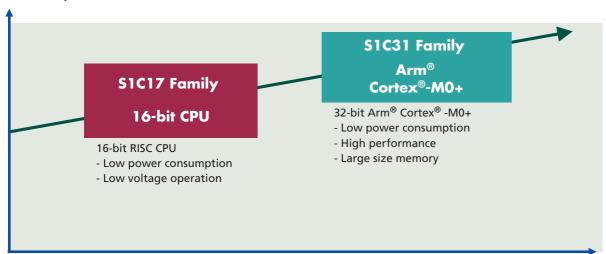
s MC

Epson microcontroller overview

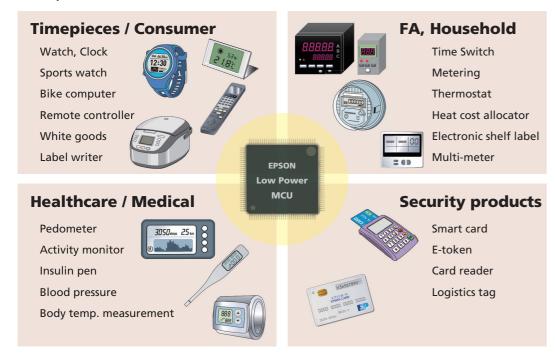
■ Low power microcontrollers

The technologies of low voltage operation and low power consumption acquired over the years through the development of 4-bit microcontrollers for watches and electronic shelf labels (ESL) are inherited by 16- and 32-bit microcontrollers today. The product lineup has been expanded, while achieving better throughputs. The display functions range from small-sized segment LDC drive to QVGA color display. A wide array of sensor interfaces recently attracting attention are also available. In addition to digital SIO such as SPI, UART, and I²C and the low power ADCs, the Epson original frequency conversion type ADC is capable of supporting measurements by resistance thermometer sensors and humidity sensors. A variety of these functions, low power technology and a highly efficient processor are all built into a single chip. With this one-chip solution, Epson continues to offer optimum products for small-sized battery-driven equipment, operation panel controllers, and sensor built-in healthcare products and housing equipment.

■ CPU Core Lineup



■ Application Example

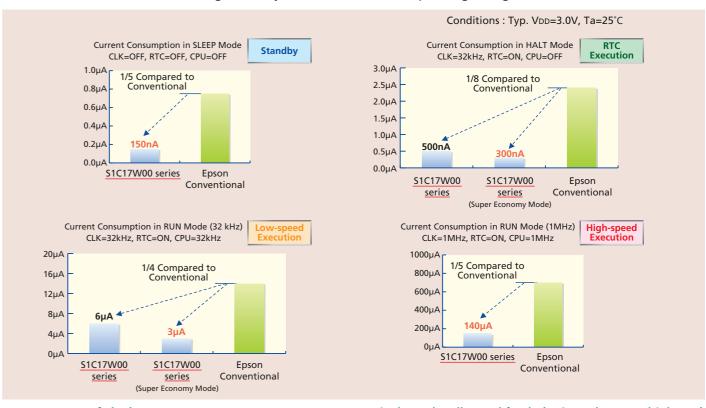


Features of Epson microcontrollers

MCUs

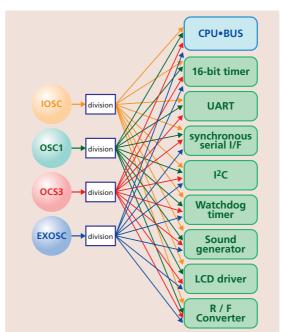
■ Lowest Current Consumption (16-bit microcontrollers)

In most cases, the S1C17 Family of products will allow customers currently using 8-bit microcontrollers to enjoy higher performance with the same power consumption. In addition, it will enable customers already using 16-bit/32-bit microcontrollers to benefit from longer battery life as a result of low operating voltage.



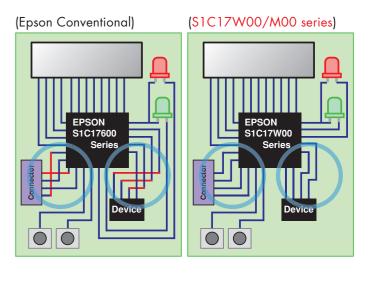
■ Four types of clock sources

Four types of characteristic clock sources can be freely selected for each circuit.



■ Terminals can be allocated freely (Universal Port Multiplexers)

SPI, I²C, UART, 16-bit PWM, and other terminals can be freely allocated as individual UPMUX terminals using software.



MCUs Features of Epson microcontrollers

Features of Epson microcontrollers

MCUs

■ Supporting various types of LCD

• Black & White LCD driver

- Segment LCD driver

- 12 to 88seg x 4/8com
- 1/3 bias LCD voltage booster built-in

- Dot Matrix LCD driver

- 56 to 128seg x 16/24/32/64com
- 1/4,1/5 bias LCD voltage booster built-in

Models containing Black & White LCD driver:

- S1C17W10 group
- S1C17W20 group
- S1C17W30 group
- S1C17M30 group
- S1C17M40 group
- S1C31W00 series

Built-in power supply circuit



Segment LCD



Dot matrix LCD



LCD controller

- STN/TFT LCD controller

- 320 x 240monochrome / 320 x 240 (QVGA)16gradations

- Memory display controller

- 300 x 300 6-bit color / 640 x 640 Black & White
- Supporting graphic engine function

Models containing LCD controller:

- S1C17800 series
- S1C31D00 series

Segment EPD driver

- 42 to 256seg + TP/BP
- Voltage booster built-in

Models containing EPD driver:

- S1C17F00 series

Segment LED drive

- 8seg x 5com supporting 5V

Models containing LED driver:

- S1C17M12/M13

Memory display



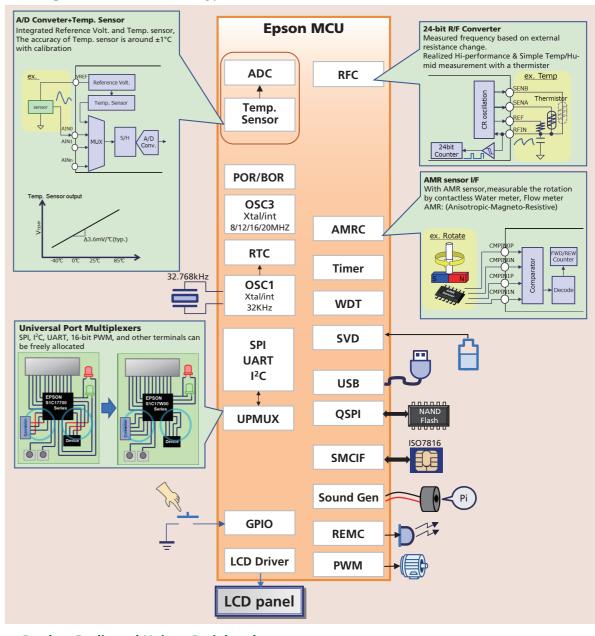
Segment EPD



Segment LED

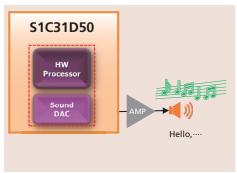


■ A large number of different types of interfaces are included



■ Product Dedicated Unique Peripherals





*: Peripheral circuits configured by products are different.

Suitable for wearable and industrial control devices

10

Arm® microcontroller with LCD driver S1C31W00 Series

Arm® microcontroller with a memory display controller "\$1C31D01"

■ General

The S1C31W00 series is 32-bit MCU with an Arm® Cortex®-M0+ processor included that features low-power operation. It integrates LCD driver (max. 2,560-dot) and a lot of serial interface circuits.

Large capacity memory

Large capacity memory corresponding to market trend of multi functionality is integrated on a single chip. It is possible to store and operate user programs that size is increasing by complicated software design.

Built-in high resolution LCD driver

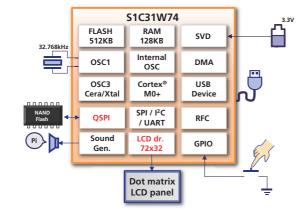
S1C31W series can drive dot-matrix or 7-segment LCD by built-in LCD driver. It equips internal constant voltage circuit that has been cultivated over the Epson traditional products, and can maintain display quality that is not affected by the remaining battery level. The contrast can be adjusted by software. It offers optimum and flexible design for user's product development.

Wide variety of interface

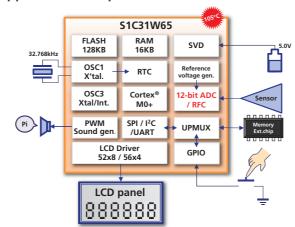
In addition to UART, SPI and I²C, it supports Quad-SPI (QSPI) which can communicate with external serial flash memory at high speed. An R/F converter for temperature and humidity measurement, USB FS 2.0 device controller, Universal port multiplexers that increase board layout design flexibility are also supported.

* It depends on the product which interface are supported.

■ Application example: Sport watch



■ Application example: Industrial control device



■ General

The S1C31D01 is a 32-bit MCU with an Arm® Cortex®-M0+ processor included that features low-power operation.

It integrates a lot of serial interface circuit, a memory display controller, and a voltage booster.

Memory Display Controller (MDC)

MDC supports several panel interfaces for each memory display. It includes graphics hardware acceleration functions such as rotation of frame buffer image to panel, Image/bitmap copy with scaling/rotation/horizontal and vertical shearing/alpha-blending*, Line/Rectangle/Ellipse/Arc drawing with filled and unfilled.

It can contributs to reduce software load by dedicated hardware.

Power booster circuit

The S1C31D01 generates supply voltages for memory display (VMDH/ VMDL) with programmable power booster curcuit. It is possible to reduce external components.

Small size package

Wafer level Chip Size Package (WCSP) is supported as same size with chip. It is suitable for various applications which have limited mounting area on the print circuit board.

Lineup

Epson prepares CPU-less dedicated memory display controller "S1D13C00" for the customers who already have Host CPU. It supports same features with S1C31D01 about graphic accereration function and power booster circuit. There is a variety of products that can be selected according to your system.

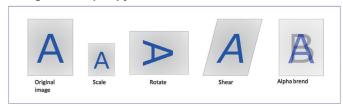
■ Examples of Graphic Acceleration Drawing Engine



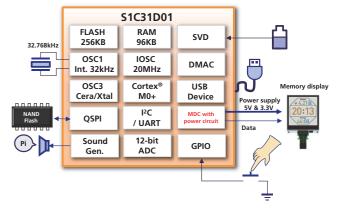
Imge / Bitmap copy

Suitable for battery-driven wearable products

MCUs



■ Application Example: Sport watch



* Alpha-blending: supported at 6-bit color only

■ S1C31W00 Series Products overview

	Display		Operation clock	k		Suppl	y current		Power supply		Memory		I/O		Tin	ner				SIO				Analog		Res	set		Othe	ers	Form of deli	very
Products	LCD Driver seg×com	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	mode0 Operating [μΑ] (Typ.)	mode1 Operating [μΑ] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	Display RAM [Byte]	RAM [Byte]	VO port	16-bit timer	16-bit PWM timer	Watchdog timer	Real-time clock	UART	SPI	Quad SPI	l²C	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (12-bit)	SVD	POR	BOR	Sound	USB	Special function	Package	Chip
S1C31W65	52 x 8 56 x 4	33M	32.768k	32k/1M/2M/ 8M/12M/16M/ 24M/32M	0.3	1.5	195	130	1.8 to 5.5	128K	112	16K	64	8	3 x 4	1	1	2	2	-	2	1	1	7	1	0	0	1	-	DMA	TQFP14-100	-
S1C31W73	96 x 16 88 x 24 80 x 32	33M	32.768k	32k/1M/2M/ 8M/12M/16M/ 24M/32M	0.7	2.0	214	150	1.8 to 5.5	384K	768	32K	73	8	2 x 4	1	1	2	2	1	2	1	1	7	1	0	0	1	1	DMA	QFP21-216	0
S1C31W74	88 x 16 80 x 24	21M	32.768k	1M/2M/8M/ 12M/16M/20M	0.4	1.7	250	150	1.8 to 3.6	512K	704	128K	71	4	2 x 2	1	1	2	1	1	2	1	1	_	2	0	0	1	1	-	VFBGA8H-181	0

■ S1C31D00 Series Products overview

	Display		Operation clo	ock		Supply	current		Power supply	Mem	nory	VO		Tim	ner				SIO			A	Analog		Res	et		Othe	ers	Form of deli	ivery
Products	Display controller	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	mode0 Operating [µA] (Typ.)	mode1 Operating [µA] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	RAM [Byte]	I/O port	16-bit timer	16-bit PWM timer	Watchdog timer	Real-time clock	UART	SPI	Quad SPI	ΡC	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (12-bit)	SVD	POR	BOR	Sound	USB	Special function	Package	Chip
S1C31D01	MDC	21M	32.768k	32k/1M/2M/ 8M/12M/16M/20M	0.46	1.7	250	155	1.8 to 5.5	256K	96K	57	8	2 x 6	1	1	3	2	1	2	1	-	7	1	0	0	1	1	DMA	WCSP96 TQFP14-80 VFBGA5H-81	0
S1C31D50 / 51	-	16M	32.768k	32k/4M/8M/16M	0.46	1.8	250	155	1.8 to 5.5	192K	8K	39 55 71 91	8	2 x 4	1	1	3	3	1	3	1	1	5 7 8	1	0	0	-	-	DMA Sound HW	TQFP12-48 QFP13-64 TQFP14-80 QFP15-100	-
S1C31D41	-	16M	32.768k	32k/4M/8M/16M	TBD	TBD	TBD	TBD	1.8 to 5.5	96K	8K	25 39 55	8	2 x 4	1	1	3	3	1	3	1	1	6 7 8	1	0	0	-	-	DMA Sound HW	TQFP12-32 TQFP12-48 TQFP13-64	-

ideal sound solution for home appliances and electronics

Arm® microcontroller with Dedicated Sound Hardware "\$1C31D50/51/41"

■ General

The S1C31D50/51/41 is a 32-bit Arm® Cortex®-M0+ MCU which integrates a specific hardware block called the HW Processor.

HW Processor

The HW Processor can perform 2ch Voice/Audio Play, Voice Speed Conversion, and Self Memory Check without using any CPU resources.

2ch mixing play

A dedicated HW Processor provides 2-channel sound on a single MCU chip. The use of two channels enables music and voice to be played simultaneously. The audio guidance becomes more elegant and warmer.

Voice Speed Conversion

The speed of the easy-to-hear voice depends on the end user. This functuion enable to adjust the speed by the end user.

Buzzer Voice play(D51/D41)

By making it possible to output voice guidance sound like error and

warning messages on a buzzer instead of a speaker, the usability of the MCU is increased. Common buzzer sound output performance is often very poor because of low volume and limited bandwidth. Epson improved buzzer performance by using new development algorithm.

Pitch conversion(D41)

The pitch of the comfortable-to-hear voice depends on the end user. This functuion enable to adjust the speed by the end user.

High-compression Sound Algorithm

Epson high-compression algorithm(EOV) cultivated in Epson LSI business is inherited. For example, the data size of 1min voice at 15.625kHz sampling frequency is about 120KB. It is 1/4 size of the data created by ADPCM.

Self-Memory Check

HW processor can detect failures in built-in RAM, built-in Flash, and external SPI-Flash memories without using CPU resources.



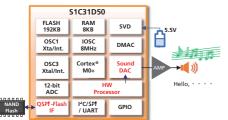




■ Block Diagram

	S1C31D50	S1C31D51	S1C31D41									
Flash	192KB(For Prog	gram and Sound)	96KB(For Program and Sound)									
RAM	8KB +14KB HW Processor not active	10KB +12KB HW Processor not active	8KB +18KB HW Processor not active									
HW Processor	2ch mixing play(ch0 and ch1) Voice Speed Conversion(only ch0) Voice Pitch Conversion(D41) Self Memory Check(On Chip RAM, On Chip F	lash, External SPI-Flash)										
Sound DAC	Sampling Frequency: 15.625kHz											
Serial Interface	SPI(3ch), UART(3ch), I ² C(3ch), QSPI(1ch)											
Sound Play Method	AMP + Speaker	Simple circu	Speaker uit + Speaker uit + Buzzer									
ADC	12-bit (Ma	ax. 8-port)	12-bit (Max. 8-port, 1-port for temperature sensor									
SVD	VDD: 28 levels (1.8V to 5.0V)/External voltage	ob: 28 levels (1.8V to 5.0V)/External voltage: 32 lavels (1.2V to 5.0V)										
DMA	4ch (Memory ⇔ Memory, Memory ⇔ Peripher	al)										
RFC	CR oscillation type 24-bit counters											
Timers	16-bit Timer (8ch), 16-bit PWM (2ch), WDT, F	RTC										
Power Supply	1.8V to 5.5V V _{DD} 3.3V SPI-Flash Interface Power Supply											
Flash Programming	2.7V to 5.5V		2.2V to 5.5V									
Clock Frequency	Max. 16MHz (internal power: 1.8V) Max. 1.8MHz (internal power: 1.2V)		TBD									
Power Consumption	Standard Mode Low Power Mode Low Power Mode RUN: $250\mu A/MHz$ (internal: RUN: $150\mu A/MHz$ (internal: SLEEP: $0.4\mu A$, RTC mode: $0.9\mu A/MHz$	1.2V) Max. 1.8MHz	TBD									
Package	P-TQFP048 P-LQFP064 P-TQFP080 P-LQFP100	-1010-0.50 -1212-0.50	P-TQFP032-0707-0.80 P-TQFP048-0707-0.50 P-LQFP064-1010-0.50									
IEC-60730		supported by Sample SW										

■ Block Diagram



■ Applications

Boiler Remote Controller Fire/Smoke Alarm

MCUs

Voice Creation PC Tool, Simple sound play interface, easy sound data update in market

MCUs

S1C31D50/51/41 Development Environment provides User-Friendly Substantial Development, this makes it easy to create natural voice data and play the sound.

■ Epson Voice Creation PC Tool

Using Epson Voice Creation PC Tool, natural voice data can be created by just PC, so no need to struggle studio recording, announce arrangement and additional cost. Typically only text input to the tool is enough to create the voice data. The tool also supports phrase combination, pronunciation adjust and importing existing WAV file a customer already has.

[Supported Languages]

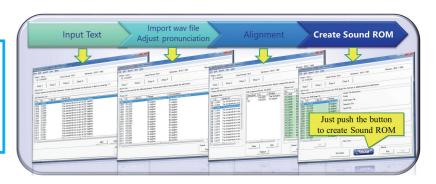
Asia : Japanese, Chinese (Mandarin), Korean

America : American English, American Spanish,

Canadian French

Europe : British English, German, French, Spanish,

Italian, Russian



■ Link between Voice creation Tool and IC

Epson Voice Creation PC tool also makes it easy to develop firmware. A firmware engineer does not need to care phrase combination and delay among phrases etc, because all information is included in Sound ROM and Hardware Processor. By just setting the Sentence Number on the tool to IC register, the sound can be played.

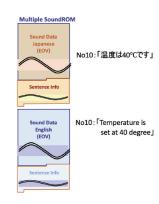


■ Easy to add, management of the languages

By Multiple SondROM capability, it's easy to add/modify on the market, management of the languages.

By having same meaning sentence on each language, the sequence can be shared.

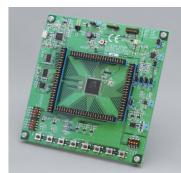
It's just set start address and the size to switch SoundROM.



■ Evaluation Board

4 languages sound demo with melody is preset. Pushing the button on the evaluation board, 2ch mixing sound can be played.

Also customers can write new sound ROM Data from PC to this board and play own sound easily.



MCU 13

S1C17 Family 16-bit microcontrollers

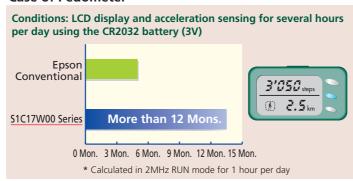
S1C17 Family 16-bit microcontrollers

■ World realized by low power consumption of the S1C17W00 Series



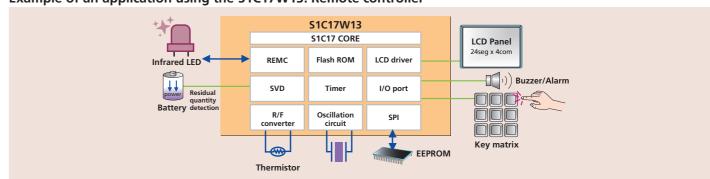


Case of Pedometer



■ S1C17W00 Series Application examples

Example of an application using the S1C17W13: Remote controller



■ S1C17W00 Series Products overview

	Display		Operation clock			Supply	current		Power supply	Men	nory	VO		Tir	ner				SIO				Analog			Ot	hers	Form of deliv	very
Products	LCD Driver seg×com	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	32kHz Operating [µA] (Typ.)	1MHz Operating [µA] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	RAM [Byte]	I/O port	16-bit timer	16-bit PWM timer	Watchdog timer	Real-time clock	UART	SPI	QSPI	I²C	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (12-bit)	SVD *4	Sound	Multiplie r/Divider	Special function	Package	Chip
S1C17W00 series /	W00 group						le to low voltage o							highly efficacity of the						t voltage, t	o drive an I	C with a lo	w power c	onsumpti	ion operation	on beyond	4-bit MCUs.		
S1C17W03	-	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	16K *3	2K	35 24	4	2 x 2	1	1	2	2	-	1	1	2* ⁵	6 5	1	1	1	-	TQFP12-48 SQFN5-32	0 -
S1C17W04	-	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	32K *3	2K	35 24	4	2 x 2	1	1	2	2	-	1	1	2*5 1	6 5	1	1	1	-	TQFP12-48 SQFN5-32	o -
S1C17W00 series /	W10/W20/W30 group						ole to low voltage with the powerful p							d highly efficience					al constan	nt voltage,	to drive an	IC with a lo	ow power	consumpt	tion operat	ion beyond	4-bit MCUs. This produ	uct is equipped with a	built-in RTC
S1C17W12	26 x 4	4.2M	32.768k	32k/250k/ 384k/500k/ 700k/1M/	0.15	0.3	2	140	1.2 to 3.6	48K *3	2K	32	3	2 x 2	1	1	2	1	-	1	1	2	-	1	1	1	LED pin x 2	-	0
	18 x 4 26 x 4		-	2M/4M 32k/250k/ 384k/500k/		1.5	2		124.26	401/		26 32										2						SQFN7-48 QFP13-64	
S1C17W13	18 x 4 20 x 4 *7	4.2M	32.768k	700k/1M/ 2M/4M	0.15	0.3	4	140	1.2 to 3.6	48K *3	2K	26	3	2 x 2	1	1	2	1	-	1	1	-	-	1	1	1	LED pin x 2	SQFN7-48 TQFP12-48	0
S1C17W14	54 x 4 50 x 8	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	3	200	1.2 to 3.6	48K *3	4K	33	3	2 x 2	1	1	2	2	-	1	1	1	-	1	1	1	-	QFP15-100	0
S1C17W15	34 x 4 30 x 8 32 x 4 28 x 8 24 x 4	4.2M	32.768k	500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	64K *3	4K	36 33 28	3	2 x 2	1	1	2	1	-	1	-	4 *5	-	1	1	1	-	QFP15-100 TQFP14-80 SQFN9-64	0
S1C17W16	20 x 8 60 x 4 56 x 8	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	3	200	1.2 to 3.6	64K *3	8K	40	5	2 x 2	1	1	2	3	-	1	1	2 *5	4	1	1	1	-	TQFP13-64 TQFP15-128	0
S1C17W18	48 x 4 44 x 8 32 x 4 28 x 8 24 x 4	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	2	140	1.2 to 3.6	128K (*3)	8K	68 59 49	4	3 x 2	1	1	2	2	-	1	1	2 *5	7	1	1	1	Temperature sensor	TQFP15-128 TQFP14-80 SQFN9-64	0
S1C17W22	20 x 8 72 x 4/8 64 x 16 56 x 24	4.2M	32.768k	500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	64K *3	4K	42	2	2 x 2	1	1	1	1	-	1	1	2 *5	-	1	1	1	-	TQFP15-128	0
S1C17W23	72 x 4/8 64 x 16 56 x 24	4.2M	32.768k	500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	96K *3	8K	42	4	3 x 2	1	1	2	2	-	1	1	2	6	1	1	1	-	TQFP15-128	0
S1C17W34	80 x 16 64 x 32	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.4	3	150	1.2 to 3.6	128K (*3)	12K	53	4	3 x 2	1	3	2	2	-	1	1	2 *5	7	1	1	1	Temperature sensor	QFP21-176	0
S1C17W35	80 x 16 64 x 32	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.4	3	150	1.2 to 3.6	256K (*3)	12K	53	4	3 x 2	1	3	2	2	-	1	1	2 *5	7	1	1	1	Temperature sensor	QFP21-176	0
S1C17W36	80 x 16 64 x 32	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.4	3	150	1.2 to 3.6	384K (*3)	16K	53	4	3 x 2	1	3	2	2	-	1	1	2 *5	7	1	1	1	Temperature sensor	QFP21-176	0

^{*1:} During erasing / programming in flash memory (VDD): 1.8V to 3.6 V

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^{*2:} During operations LCD (VDD): 2.5V to 3.6V

^{*3:} During erasing / programming voltage in flash memory (VPP): The external applying of 7.5V / 7.5V (Typ.) is needed. (*3) can be rewritten even with internal power supply.

^{*4:} SVD is an abbreviation for Supply Voltage Detector.

^{*5:} Independent operation for each channel.

^{*6:} During erasing / programming in flash memory (VDD): 2.7V to 3.6V, 2.4V to 3.6V during the external applying VPP=7.5V/7.5V(Typ.)

^{*9:} During erasing / programming in flash memory (VDD): 2.4V to 3.6 V

^{*7:} External voltage application mode only.

^{*8:} Including Input port and Output port.

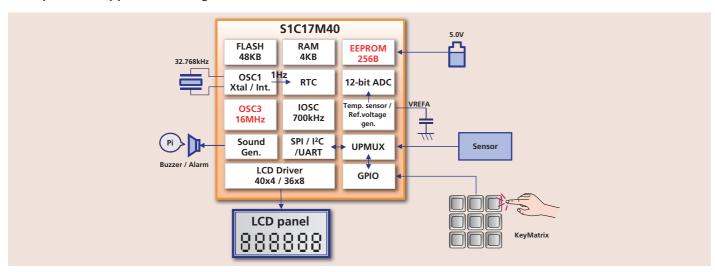
S1C17 Family 16-bit microcontrollers

S1C17 Family 16-bit microcontrollers

MCUs

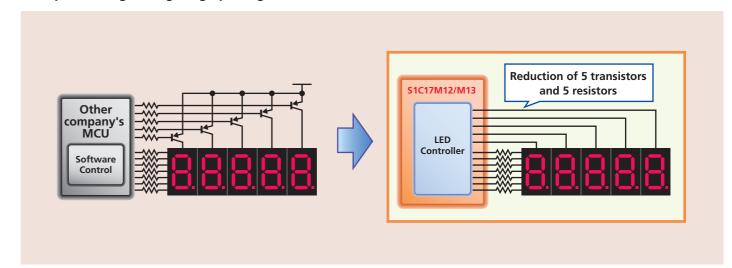
■ S1C17M00 Series Application examples

Example of an application using the S1C17M40: FA/Industrial control device



■ S1C17M00 Series Function introduction

Example of 7 seg LED lighting up using the S1C17M12/M13



■ S1C17M00 Series Products overview

	Displ	ay		Operation clo	ick		Supply	y current		Power supply		Memory		I/O		Tin	ner				SIO				Analog		Re	set		Oth	ners	Form of de	livery
Products	LCD Driver seg×com	Display controller	High- speed [Hz] (Max.)	Low- speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	32kHz Operating [µA] (Typ.)	1MHz Operating [µA] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	EEPROM [Byte]	RAM [Byte]	VO port	16-bit timer	16-bit PWM timer	Watchdog timer	Real-time clock	UART	SPI	Quad SPI	PC	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (12-bit)	SVD*4	POR	BOR	Sound	Multiplie r/Divider	Special function	Package	Chip
S1C17M00 series		It is an applic supporting p	ation specializ ower supply v	ed series. It is oltages from	a 16-bit MCU w 1.8 V to 5.5 V.	ith Flash mem	ory compatib	le with high pro	cessing while	achieving low	power consum	ption,																					
S1C17M01	32 x 4 28 x 8	-	16.3M	32.768k	7.37M	0.35	0.8	12.5	210	1.8 to 5.5	32K *3	-	4K	19	5	-	1	1	1	2	-	1	-	1	-	1	0	-	-	-	AMRC	TQFP13-64	0
S1C17M10	88 x 8 80 x 16	-	16M	32.768k	32k/ 4M/8M/ 12M/16M	0.16	0.6	4	145	1.8 to 5.5	64K (*3)	-	4K	33	5	1 x 2	1	1	1	1	-	1	-	-	-	1	0	-	-	1	SMCIF	TQFP15-128	0
S1C17M12	-	LED controller 8x5	16.8M	-	4M/8M/ 12M/16M	0.35	40	-	150	1.8 to 5.5	16K *3	-	2K	39	4	1 x 2	1	-	1	2	-	1	1	-	-	1	0	0	-	1	High current port x 5	TQFP12-48	0
S1C17M13	-	LED controller 8x5	16.8M	-	4M/8M/ 12M/16M	0.35	40	-	150	1.8 to 5.5	16K *3	-	2K	39	4	1 x 2	1	-	1	2	-	1	1	-	8	1	0	0	-	1	High current port x 5	TQFP12-48	0
S1C17M20	-	-	21M	- 32.768k	32k/700k/ 12M/16M/20M	0.36	1.5 0.7	5.5 5	160	1.8 to 5.5	16K (*3)	-	2K	18 24	4	2 x 2	1	1	2	2	-	1	1	-	4 6	1	0	0	1	1	-	SQFN4-24 SQFN5-32	-
S1C17M21	-	-	21M	32.768k	32k/700k/ 12M/16M/20M	0.36	0.7	5	160	1.8 to 5.5	16K (*3)	-	2K	24	4	2 x 2	1	1	2	2	-	1	1	-	6	1	0	0	1	1	-	TQFP12-32	_
S1C17M22	-	-	21M	32.768k	32k/700k/ 12M/16M/20M	0.36	0.7	5	160	1.8 to 5.5	16K (*3)	-	2K	40	4	2 x 2	1	1	2	2	-	1	1	2	8	1	0	0	1	1	-	TQFP12-48	-
S1C17M23	-	-	21M	- 32.768k	32k/700k/ 12M/16M/20M	0.36	1.5 0.7	5.5 5	160	1.8 to 5.5	32K (*3)	-	2K	18 24	4	2 x 2	1	1	2	2	-	1	1	-	4 6	1	0	0	1	1	-	SQFN4-24 SQFN5-32	-
S1C17M24	-	-	21M	32.768k	32k/700k/ 12M/16M/20M	0.36	0.7	5	160	1.8 to 5.5	32K (*3)	-	2K	24	4	2 x 2	1	1	2	2	-	1	1	-	6	1	0	0	1	1	-	TQFP12-32	-
S1C17M25	-	-	21M	32.768k	32k/700k/ 12M/16M/20M	0.36	0.7	5	160	1.8 to 5.5	32K (*3)	-	2K	40	4	2 x 2	1	1	2	2	-	1	1	2	8	1	0	0	1	1	-	TQFP12-48	-
S1C17M30	26 x 4 22 x 8	-	16.8M	32.768k	32k/700k/ 12M/16M	0.2	0.7	5	160	1.8 to 5.5	48K (*3)	256 *8	4K	38	4	3 x 2	1	1	2	2	-	1	1	2	2	1	0	0	1	1	-	TQFP12-48	-
S1C17M31	26 x 4 22 x 8	-	16.8M	-	32k/700k/ 12M/16M	0.2	1.4	5.5	160	1.8 to 5.5	48K (*3)	256 *8	4K	38	4	3 x 2	1	1	2	2	-	1	1	2	2	1	0	0	1	1	-	TQFP12-48	-
S1C17M32	42 x 4 38 x 8 *6	-	16.8M	32.768k	32k/700k/ 12M/16M	0.2	0.7	5	160	1.8 to 5.5	64K (*3)	256 *8	4K	54	4	3 x 2	1	1	2	2	-	1	1	2	2	1	0	0	1	1	-	TQFP13-64	-
S1C17M33	50 x 4 46 x 8	-	16.8M	32.768k	32k/700k/ 12M/16M	0.2	0.7	5	160	1.8 to 5.5	96K (*3)	32 to 512	4K	66	4	3 x 2	1	1	2	2	-	1	1	2	5	1	0	0	1	1	-	TQFP14-80	0
S1C17M34	37 x 4 33 x 8	-	16.8M	32.768k	32k/700k/ 12M/16M	0.2	0.7	5	160	1.8 to 5.5	64K (*3)	256 *8	4K	52	4	3 x 2	1	1	2	2	-	1	1	2	5	1	0	0	1	1	-	TQFP13-64	-
S1C17M40	40 x 4 36 x 8	-	16.8M	32.768k	32k/700k/ 16M	0.25	0.7	5	-	1.8 to 5.5	48K	256	2K	55	4	3 x 2	1	1	3	2	-	1	1	-	4	1	0	0	1	1	-	QFP13-64	-
3101710140	28 x 4 24 x 8	-	16.8M	-	32k/700k/ 16M	0.25	1.4	5.5	-	1.8 to 5.5	48K	256	2K	41	4	3 x 2	1	1	3	2	-	1	1	-	3	1	0	0	1	1	-	TQFP12-48	-

*9: During erasing / programming in flash memory (VDD): 2.4V to 5.5V

^{*1:} During erasing / programming in flash memory /EEPROM programming (Voo): Ve≥2.2V to 5.5V *2: During erasing / programming in flash memory (Voo): 2.7V to 5.5 V, 2.4V to 5.5V during the external applying Ve≥7.5V / 7.5V (Typ.)

^{*3:} During erasing / programming voltage in flash memory (Vpp): The external applying of 7.5V / 7.5V (Typ.) is needed. (*3) can be rewritten even with internal power supply.

^{*4:} SVD is an abbreviation for Supply Voltage Detector. *5: Output dedicated port 1 included

^{*6:} External voltage application mode only. to 5.5V

^{*7: (}MR sensor controller) Operation (Vbb): 2.0V to 5.5V *8: AMRC Flash area is used.

S1C17 Family 16-bit microcontrollers

S1C17 Family 16-bit microcontrollers

MCUs

■ S1C17 Long-running Series

	Display		Operation clock	k		Suppl	y current		Power supply		Memory		VO				Timer						SIO				Analog			Other	rs	Form of deliv	very
Products	LCD Driver seg×com	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	32kHz Operating [µA] (Typ.)	1MHz Operating [µA] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	Mask ROM [Byte]	RAM [Byte]	I/O port	8-bit timer	16-bit timer	16-bit PWM timer	Stopwatch	Watchdog timer	Clock	Real-time clock	UART	SPI	I²C master	I²C slave	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (10-bit)	SVD *5	Sound	Multiplier /Divider	Special function	Package	C
1C17100/600 serie	es			it MCU with imp										n's 4/8-bit hcare devi																			
1C17153	32 x 4	-	32.768k	500k/1M/2M	0.13	0.42	4	160	2.0 to 3.6	-	16K	2K	12	1	-	1	-	1	1	1	1	1	-	-	-	-	-	1	1	1	-	-	
1C17121	40 x 4 36 x 8	4.2M	32.768k	2.7M	0.15	0.9	7	250	1.8 to 3.6	-	32K	2K	36	3	3	1	1	1	1	-	2	1	1	1	1	2	8	1	-	1	-	TQFP14-100	
1C17651	20 x 4	4.2M	32.768k	32k/500k/ 1M/2M	0.09	0.42	10	350	2.0 to 3.6	16K *3	-	2K	12	1	-	1	-	1	1	1	1	1	-	-	-	-	-	1	1	1	-	TQFP13-64	
1C17653	32 x 4	4.2M	32.768k	32k/500k/ 1M/2M	0.09	0.42	10	350	2.0 to 3.6	16K *3	-	2K	12	1	-	1	-	1	1	1	1	1	-	-	-	-	-	1	1	1	-	TQFP14-80	
1C17656	32 x 4	-	32.768k	500k/ 1M/2M/4M	0.13	0.5	7.3	280	1.8 to 3.6	24K *4	-	2K	20	1	-	1	-	1	1	1	1	1	-	-	-	1	-	1	1	1	-	TQFP14-80	
1C17611	12 x 4 8 x 8	8.2M	32.768k	2.7M	0.6	2.0	12	400	1.8 to 3.6	32K *6	-	2K	19	2	3	2	1	1	1	-	1	1	1	1	-	1	4	1	-	1	-	QFP12-48	
1C17601	20 x 4 16 x 8	8.2M	32.768k	2.7M	0.6	2.0	12	340	1.8 to 3.6	32K *6	-	2K	24	2	3	2	1	1	1	-	1	1	1	1	-	1	4	1	-	1	-	TQFP13-64	
1C17621	40 x 4 36 x 8	8.2M	32.768k	2.7M	0.75	2.5	15	410	1.8 to 3.6	32K *6	-	2K	36	3	3	1	1	1	1	-	2	1	1	1	1	2	8	1	-	1	-	TQFP14-100	
C17602	40 x 4 36 x 8	8.2M	32.768k	2.7M	0.75	2.5	15	410	1.8 to 3.6	64K *6	-	4K	36	3	3	1	1	1	1	-	2	1	1	1	1	2	8	1	-	1	-	TQFP14-100	
C17622	56 x 4 52 x 8	8.2M	32.768k	2.7M	0.75	2.3	14	400	1.8 to 3.6	64K	-	4K	47	3	3	1	1	1	1	-	2	1	1	1	1	2	8	1	-	1	-	TQFP15-128	
1C17604	40 x 4 36 x 8	8.2M	32.768k	2.7M	0.75	2.3	14	400	1.8 to 3.6	128K	-	8K	36	3	3	3	1	1	1	1	2	1	1	1	1	2	8	1	-	1	-	TQFP14-100	
1C17624	56 x 4 52 x 8	8.2M	32.768k	2.7M	0.75	2.3	14	400	1.8 to 3.6	128K	-	8K	47	3	3	3	1	1	1	1	2	1	1	1	1	2	8	1	-	1	-	TQFP15-128	
1C17500 series		[Low Power	r] This is a 16-bit	t MCU with built	in flash memo	ry, which realiz	zes high-speed p	rocessing at lov	w power consum	ption. This pro	duct is equipped	with various	feature	s, such as	a genera	l-purpose	I/O port, /	√D conve	erter input	t and serial	l I/F, and is	suitable	for contro	olling vari	ious senso	or built-in	devices, i	including	household	d appliand	ces.		
1C17564	-	24M	32.768k	2M to 12M	0.8	2.7	16	450	2.0 to 5.5	128K	-	16K	40	-	5	4	1	1	1	-	2	3	1	1	1	-	4	-	1	-	-	TQFP13-64 VFBGA5H-81	
				414/914/						1201/			88														16					QFP15-100	
1C17589	-	16.8M	32.768k	12M/16M	0.2	0.6	9	280	1.8 to 5.5	128K *4	-	16K	68 52	-	6	4 x 6	-	1	_	1	3	2	1	1	1	-	11 7	1	1	_	-	QFP14-80 QFP13-64	
51C17700 series				ed series. It is a 1 oltages from 1.8		h Flash memo	ry compatible wi	th high process	ing while achievi	ng low power	consumption,																						
51C17711	64 x 16 56 x 24	8.2M	32.768k	2.7M	1.0	2.0	12	400	1.8 to 3.6	64K *6	_	4K	29	_	4	4	1	1	1	_	1	1	1	1	1	2	8	1	_	1	-	TQFP15-128	
1C17702	88 x 16 72 x 32	8.2M	32.768k	2.7M	1.0	2.5	16	450	1.8 to 3.6	128K	-	12K	28	3	3	2	1	1	1	-	1	1	1	-	1	-	-	1	-	1	-	QFP21-176 VFBGA10H-180 VFBGA8H-181	
1C17703	120 x 16/24/32 60 x 64	8.2M	32.768k	2.7M	1.0	2.5	15	450	1.8 to 3.6	256K	-	12K	34	-	5	4	1	1	1	-	2	3	1	1	1	2	8	1	-	1	-	QFP21-216 VFBGA10H-240	
C17705	128 x 16/24/32 64 x 64	8.2M	32.768k	2.7M	1.2	2.7	18	550	1.8 to 3.6	512K	-	12K	35	-	5	4	1	1	1	-	2	3	1	1	1	2	8	1	-	1	-	VFBGA10H-240 VFBGA10H-240	
1C17800 series	0-1 X 0-1			i-bit MCU realized provides maximu				equipped with	ahundant built-	in I/E such as II	ISR various soria	l interfaces	and M	D convert	ers suitak	ale for one	eration na	nel contro	of white	home an	nliances	nd variou	is products	s with in	mproved u	ser interf	ace utilizi	ing displa	avs music	sound to	ouch panels and	Letc	
C17801	LCD Controllers	48M	32.768k	-	1.4 *10	12		6000	3.0 to 3.6	128K	– various seria	4K	99	6	2		- -			1 *11			1				8		Multiplier : O Divider : ×		BUS supported USB FS	TQFP15-128	
1C17803	LCD Controllers	33M	32.768k		1.3	5		6500	2.7 to 5.5	128K		16K	97	4	1	2		1		1	1	2 *12	1	1	1		1		DIVIDEI .X		BUS supported	TQFP15-128 TQFP14-100	

	Display		Operation clos	:k		Supply	current		Power supply		Memory		I/O				Timer						SIO				Analog		Othe	ers	Form of deliv	ery
Products	EPD Driver seg (TP/BP)	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	RTC [µA] (Typ.)	32kHz Operating [µA] (Typ.)	1MHz operating [µA] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	EEPROM [Byte]	RAM [Byte]	I/O port	8-bit timer	16-bit timer	I6bit-PWM timer	Stopwatch	Watchdog timer	Clock	Real-time clock	UART	SPI	I ² C master	I ² C slave	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter	SVD*1	Multiplier/Divider	Temparature detection circuit	Package	Chip
S1C17F50 series		[Medium and : maximize the	small segment E characteristics of	PD] The product also an e-paper display v	o includes embed vith a single chip	dded features su	ich as a real-time	clock, theoretica	l regulation, a driver	capable of wrin	nging the maxir	num	perf	ormance fr	om segmen	ted EPDs, a	and a temp	perature se	nsor. As	a result, t	he device	does not s	simply drive	e the disp	olay, but als	o correct	s temperat	ture effect	s that could	d harm displ	lay quality making it p	oossible to
S1C17F57	64 (2TP/2BP)	4.2M	32.768k	32k/500k/1M/2M	0.10	0.21	12	410	2.0 to 3.6	32K*2	-	2K	29	2	-	2	1	1	1	1	1	1	1	1	-	1	-	1	1	1	-	*3
S1C17F63	42 (1TP/1BP)	16.8M	32.768k	500k/700k/1M/ 2M/4M/8M/16M	0.45	0.11	5	305	1.8 to 5.5°5	32K ⁽⁺²⁾	256	2K	17	-	4	2 x 2	-	1	-	1	1	2	1		-	-	7	1	1	1	QFP15-100	O *3

^{*1:} SVD is an abbreviation for Supply Voltage Detector.

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^{*1:} During erasing / programming in flash memory (Vpb): 2.7V to 3.6 V
*2: During erasing / programming in flash memory (Vpb): 2.5V to 3.6 V
*3: During erasing / programming voltage in flash memory (Vpb): The external applying of 7.5V / 7.0V (Typ.) is needed.

^{*4:} During erasing / programming voltage in flash memory (V_{PP}): The external applying of 7.5V / 7.5V (Typ.) is needed. *5: SVD is an abbreviation for Supply Voltage Detector. *6: This product uses SuperFlash® technology licensed from SST UK Ltd.

^{*7:} Al pad, Au bump *8: Including Input port and Output port. *9: Resolution: 12-bit

^{*10:} Unmounted OSC1
*11: The battery backed up operation is supported.
*12: Universal serial interface (Any of UART, SPI and I²C functions can be selected.)

^{*2:} During erasing / programming voltage in flash memory (Vpp) : The external applying of 7.0V / 7.5V (Typ.) is needed. (*2) can be rewritten even with internal power supply.

^{*3:} Al pad. Au bump

^{*4:} Including Input port and Output port.

^{*5:} During erasing / programming in flash memory /EEPROM programming (VDD) : 2.2V to 5.5V

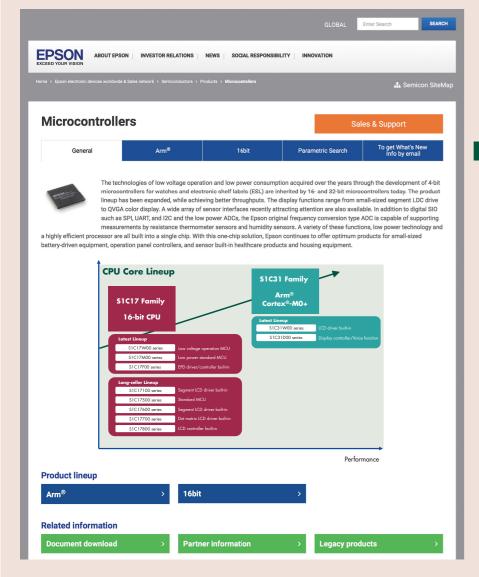
Epson MCU website

Epson MCU website

MCUs

global.epson.com/products_and_drivers/semicon/products/micro_controller/

On the Epson MCU website, you can access a variety of information required for device selection and design development.



Downloadable information

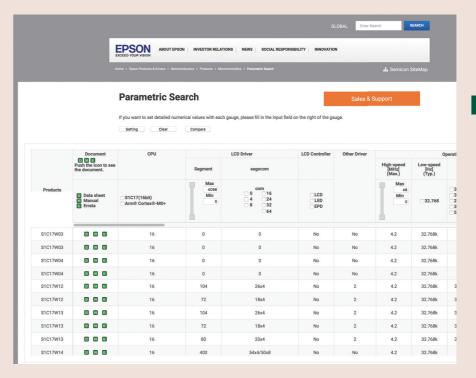
- · Hardware Development Tool
- · Software Development Tool
- · Application Note
- · Sample Program
- MP Support Tool

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You can download Data sheets, Technical manuals and Manual errata sheets.

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Downloadable information

- · Data sheets
- · Technical manuals
- · Manual errata sheets

MCUs MCU

Development environments - S1C31 Family -

Development environments - S1C31 Family -

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■ Overall development environment



■ Development support tool (Evaluation board)

- S1C31 chip built in
- Possible to evaluate the IC functions
- Provides a sample sources for various functions
- Debugging and Flash programming supported



SVTmini31W65



SVT31D01







SVT13C00

SVT31D50

Model Name	Product Name	Mounted Microcontroller Name	Remarks
SVTmini31W65	S5U1C31W65T2	S1C31W65	
SVTmini31W73	S5U1C31W73T2	S1C31W73	
SVT31W74	S5U1C31W74T1	S1C31W74	Dot matrix liquid crystal panel, Infrared LED, USB connector, Bridge Board
SVT31D01	S5U1C31D01T1	S1C31D01	Color memory display, Acceleration gyro sensor, Pulse sensor, Bridge Board
SVT31D50	S5U1C31D50T1	S1C31D50	AMP(class AB, class D), SPI-FLASH(8MB)
SVT13C00	S5U13C00K00C	S1D13C00	Color memory display, Bridge Board for connecting to Host CPU

■ 3rd Party tool inquiries

Integrated Development Environment, Debug Probe



IAR Systems K.K. www.iar.com/buy/ Debug & Trace Probes, Flasher / In-Circuit Programmers



SEGGER Microcontroller GmbH www.segger.com

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Development environments - S1C17 Family -

MCUs

GNU17 package

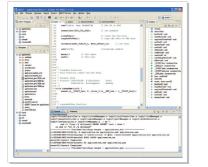
Optimized C compiler supporting 16MB space Assembler, linker and ANSI library GUI-based debugger Eclipse integrated environment



On-chip ICE, S1C17 Family products are supported. Connect with the target board with 4 pins at minimum (3 signal pins and 1 GND pin). Includes execution time measurement function. Uses USB bus power.

Can be used as a Multi Programmer. Includes firmware update function.

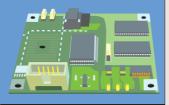
Power supply function for target devices of 3.3V.



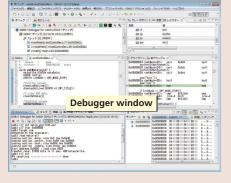








■ Development support tool (Software simulator)





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•Simulatable on PC including the LCD display, without using external debugging hardware or using an actual

Development environments - S1C17 Family -

■ Development support tool (Evaluation board)

- \$1C17 chip built in
- Possible to evaluate the IC functions
- Provides a sample software for various functions
- Debugging and Flash programming supported





























SVTmini17W18



SVT17W23



SVTmini17W36



SVTmini17564

SVTmini17W14





SVTmini17W15



SVTmini17W16









10-line cable (DCLK, DSIO, DST2, GND) Target board for product development

P2x	ort setting	chin it is possible to simulate only the LCD display
POZ POS PO4 PO5 PO5 PO5	1	chip, it is possible to simulate only the LCD display (Custom-made LCD Panels can be created) Ability to show various data at the same time in multiple windows Ability to execute frequently using commands from the tool bar or menus Function of displaying C source, program code and symbols using disassembler Consecutive program execution and 3 types of step executions 3 types of break functions
		Trace and coverage functionsAutomatic command execution using command files

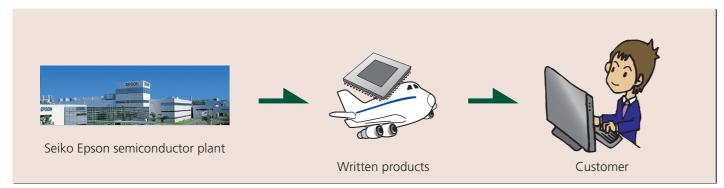
	34111111117303	34117002	21111111111111	5011762
I	Model Name	Product Name	Mounted Microcontroller Name	Remarks
ĺ	SVT17F57	S5U1C17F57T11	S1C17F57	Segment EPD panel
	SVTmini17F57	S5U1C17F57T21	S1C17F57	
	SVTmini17F63	S5U1C17F63T21	S1C17F63	Segment EPD panel
	SVT17M01	S5U1C17M01T11	S1C17M01	LCD panel, MR Sensor with EEPROM
	SVTmini17M10	S5U1C17M10T21	S1C17M10	
	SVT17M13	S5U1C17M13T11	S1C17M13	7 seg LED 5 digits, EEPROM, Infrared LED, Key matrix 3x4
	SVTmini17M25	S5U1C17M25T21	S1C17M25	
	SVT17M33	S5U1C17M33T11	S1C17M33	Reference board of remote controller
	SVTmini17M33	S5U1C17M33T21	S1C17M33	
	SVTmini17M40	S5U1C17M40T21	S1C17M40	
	SVTmini17M13	S5U1C17M13T21	S1C17M13	
	SVTmini17W04	S5U1C17W04T21	S1C17W04	
	SVTmini17W12	S5U1C17W12T21	S1C17W12	
	SVTmini17W13	S5U1C17W13T21	S1C17W13	
	SVTmini17W14	S5U1C17W14T21	S1C17W14	
	SVTmini17W15	S5U1C17W15T21	S1C17W15	
	SVTmini17W16	S5U1C17W16T21	S1C17W16	
	SVTmini17W18	S5U1C17W18T21	S1C17W18	
	SVT17W23	S5U1C17W23T11	S1C17W23	LCD panel, Piezoelectric buzzer
	SVTmini17W36	S5U1C17W36T21	S1C17W36	
	SVTmini17564	S5U1C17564T21	S1C17564	
	SVTmini17589	S5U1C17589T21	S1C17589	
	SVT17602	S5U1C17602T11	S1C17602	LCD panel, Remote control transmitter and receiver, Thermal/Humidity/Illuminance sensor
	SVTmini17611	S5U1C17611T21	S1C17611	
	SVT17656	S5U1C17656T11	S1C17656	LCD panel, Capacitive touch button, Piezoelectric buzzer
	SVTmini17656	S5U1C17656T21	S1C17656	
	SVT17702	S5U1C17702T11	S1C17702	LCD panel, Remote control transmitter and receiver
	SVTmini17803	S5U1C17803T21	S1C17803	

MCUs Flash memory writing

Flash memory writing

MCUs

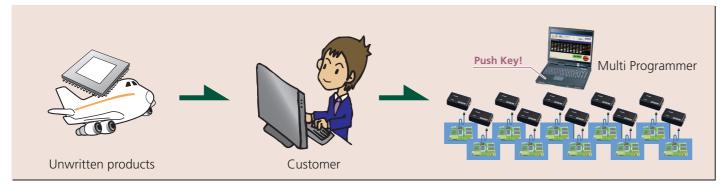
■ If you procure written products from a Epson dealer

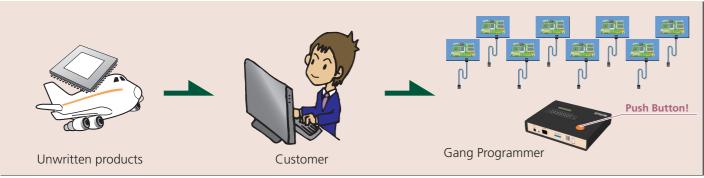


■ If you write to flash memory on your side (Single writing)

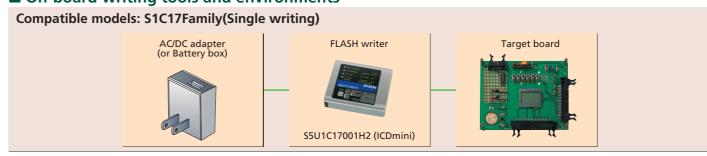


■ If you write to flash memory on your side (Simultaneous multiple writing)

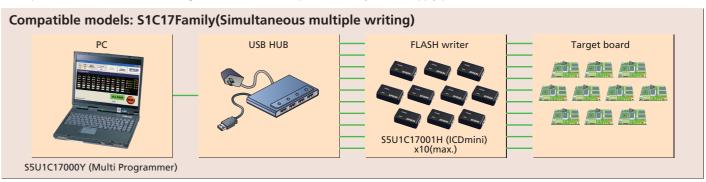




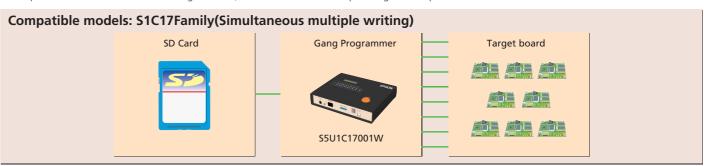
On-board writing tools and environments



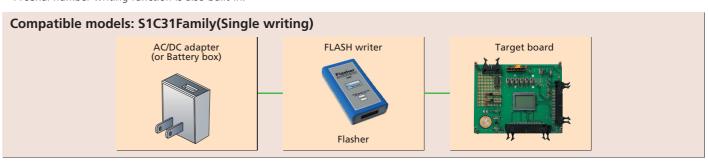
- A single S5U1C17001H2 (ICDmini) unit operates as an on-chip flash writer. Simply by pressing a button, user data previously saved in the ICDmini can be written to the internal flash ROM on the target board, or the flash ROM connected to the external bus.
- You can enjoy on-board programming easily at any location where a 5V power supply is available
- * Power supply to the target board may be required separately.
- * The product does not include the target board, and AC adapter or battery box to supply power to USB terminals.



- Up to 10 units of the S5U1C17001H (ICDmini) can be used to construct an environment enabling user data to be downloaded simultaneously to multiple targets.
- The S5U1C17000Y, Multi Programmer software that controls the ICDmini, provides user-friendly screen and simple operation.
- * Power supply to the target board may be required separately.
- * The product does not include the target board, PC and the USB hub operating on self-power



- A single S5U1C1700W unit downloads user data simultaneously to maximum 8 targets.
- SD card is used to input user data, and the operating status can be checked by LCD, LED and buzzer.
- A serial number writing function is also built-in.



• SEGGER J-Link or Flasher / Any debug probe or flash programmer that supports J-Flash software tool can be used.

MCUs Package lineup

Package lineup

MCUs

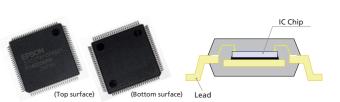
■ QFP & TQFP & SQFN

PKG type/Pin count	Body size (mm)	Lead pitch (mm)
SQFN4-24 (P-VQFN024-0404-0.50)	4 X 4 X 1.0	0.5
SQFN5-32 (P-VQFN032-0505-0.50)	5 X 5 X 1.0	0.5
TQFP12-32 (P-TQFP032-0707-0.80)	7 X 7 X 1.2	0.8
QFP12-48 (P-LQFP048-0707-0.50)	7 X 7 X 1.7	0.5
SQFN7-48 (P-VQFN048-0707-0.50)	7 X 7 X 1.0	0.5
TQFP12-48 (P-TQFP048-0707-0.50)	7 X 7 X 1.2	0.5
SQFN9-64 (P-VQFN064-0909-0.50)	9 X 9 X 1.0	0.5
QFP13-64 (P-LQFP064-1010-0.50)	10 X 10 X 1.7	0.5
TQFP13-64 (P-TQFP064-1010-0.50)	10 X 10 X 1.2	0.5
TQFP14-80 (P-TQFP080-1212-0.50)	12 X 12 X 1.2	0.5
QFP14-80 (P-LQFP080-1212-0.50)	12 X 12 X 1.7	0.5

PKG type/Pin count	Body size (mm)	Lead pitch (mm)
QFP15-100 (P-LQFP100-1414-0.50)	14 X 14 X 1.7	0.5
TQFP14-100 (P-TQFP100-1212-0.40)	12 X 12 X 1.2	0.4
TQFP15-128 (P-TQFP128-1414-0.40)	14 X 14 X 1.2	0.4
QFP21-176 (P-LQFP176-2424-0.50)	24 X 24 X 1.7	0.5
QFP21-216 (P-LQFP216-2424-0.40)	24 X 24 X 1.7	0.4

■ WCSP

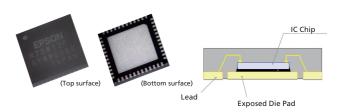
PKG type/Pin count	Body size (mm)	Ball pitch (mm)
WCSP-96 (S1C31D01)	4.5 X 4.5 X 0.7	0.4



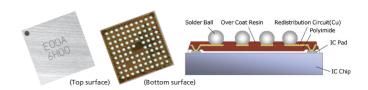
■ Compact BGA (PFBGA) & Thin type BGA (VFBGA)

PKG type/Pin count	Body size (mm)	Ball pitch (mm)
VFBGA5H-81 (P-VFBGA-081-0505-0.50)	5 X 5 X 1.0	0.5
VFBGA10H-180 (P-VFBGA-180-1010-0.65)	10 X 10 X 1.0	0.65
VFBGA8H-181 (P-VFBGA-181-0808-0.50)	8 X 8 X 1.0	0.5
VFBGA10H-240 (P-VFBGA-240-1010-0.50)	10 X 10 X 1.0	0.5

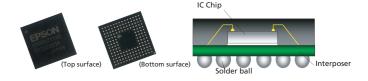
SQFN



WCSP



Thin type BGA (VFBGA)



Memo

MCUs

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